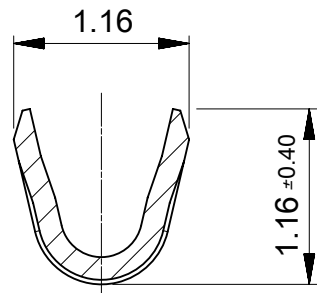
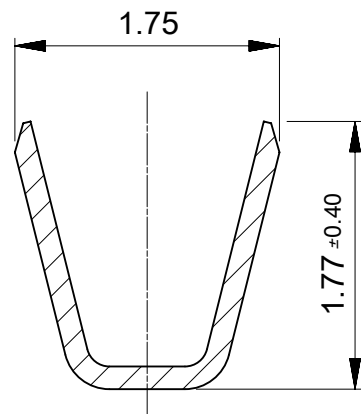
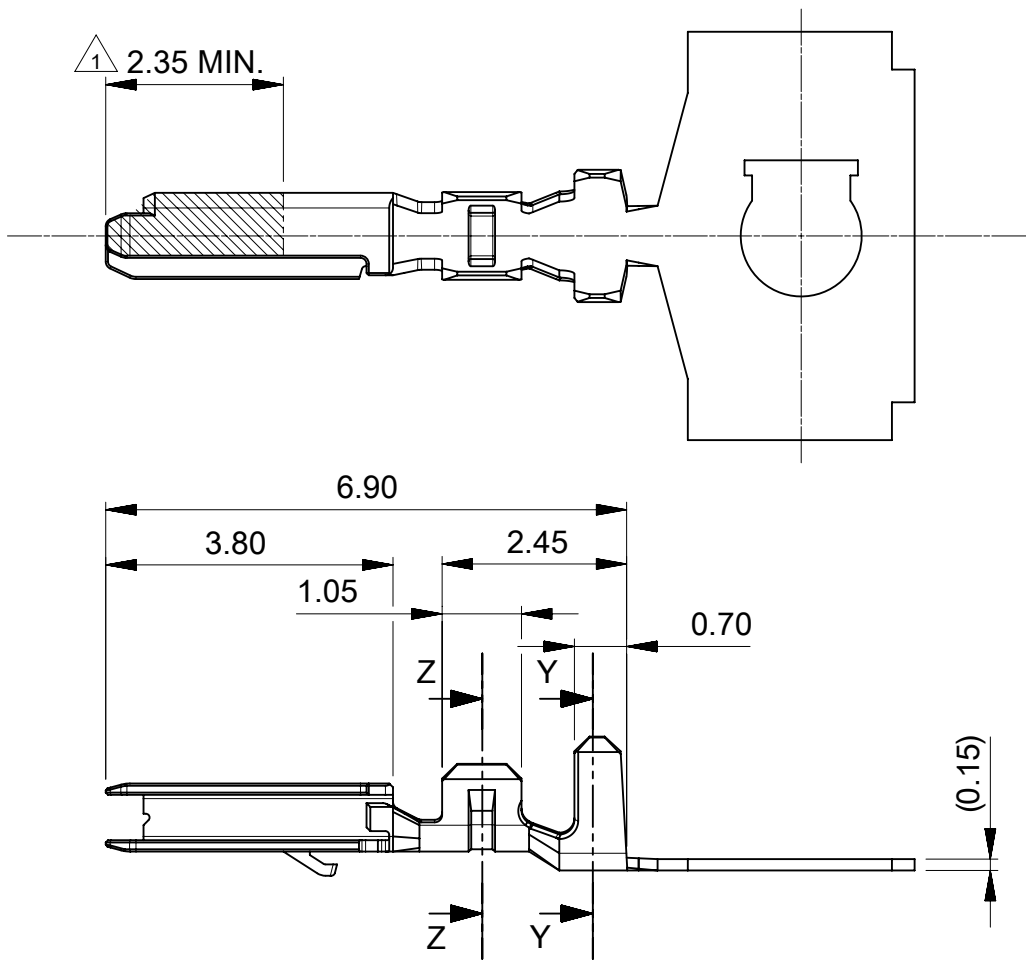
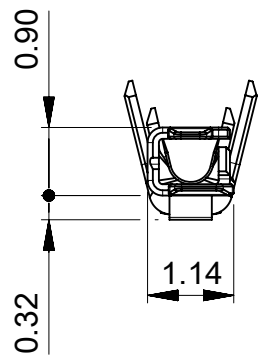


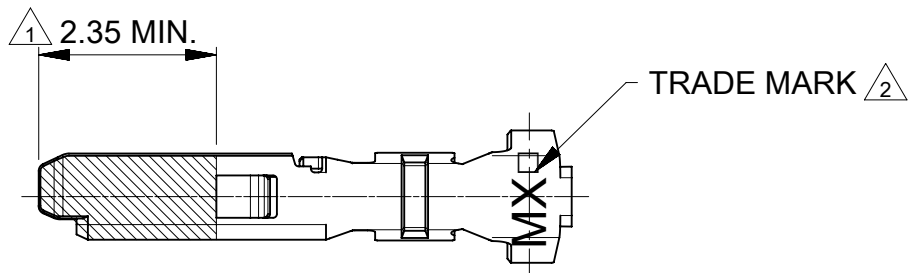
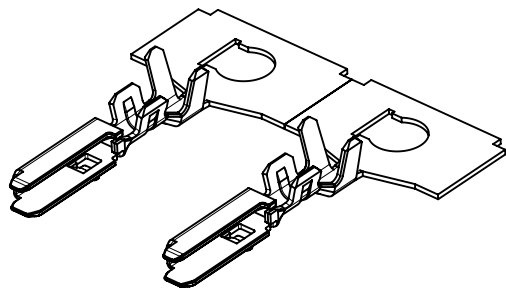
NOTES

- 1 図示の斜線部の範囲は、接点部のため
傷、打痕、汚れなどをつけないようにしてください
PLEASE DON'T DAMAGE, DON'T DENT, AND DON'T MAKE IT DIRTY,
BECAUSE THE RANGE IN THE HATCHING AREA SHOWN IN FIGURE IS THE CONTACT AREA.
- 2 トレードマーク：MXプラス1文字の製造工場を示すアルファベットにて表示。
ただし"J"はJAPANを示す。(例：MXJ)
3. 適用電線違い：502579 シリーズ (ケーブルサイズ：AWG #24-28)
SIMILAR PRODUCT THAT DIFFERENCE IS APPLICABLE CABLE SIZE: 502579 SERIES (CABLE SIZE: AWG #24-28)



SECTION Y-Y

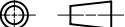
SECTION Z-Z

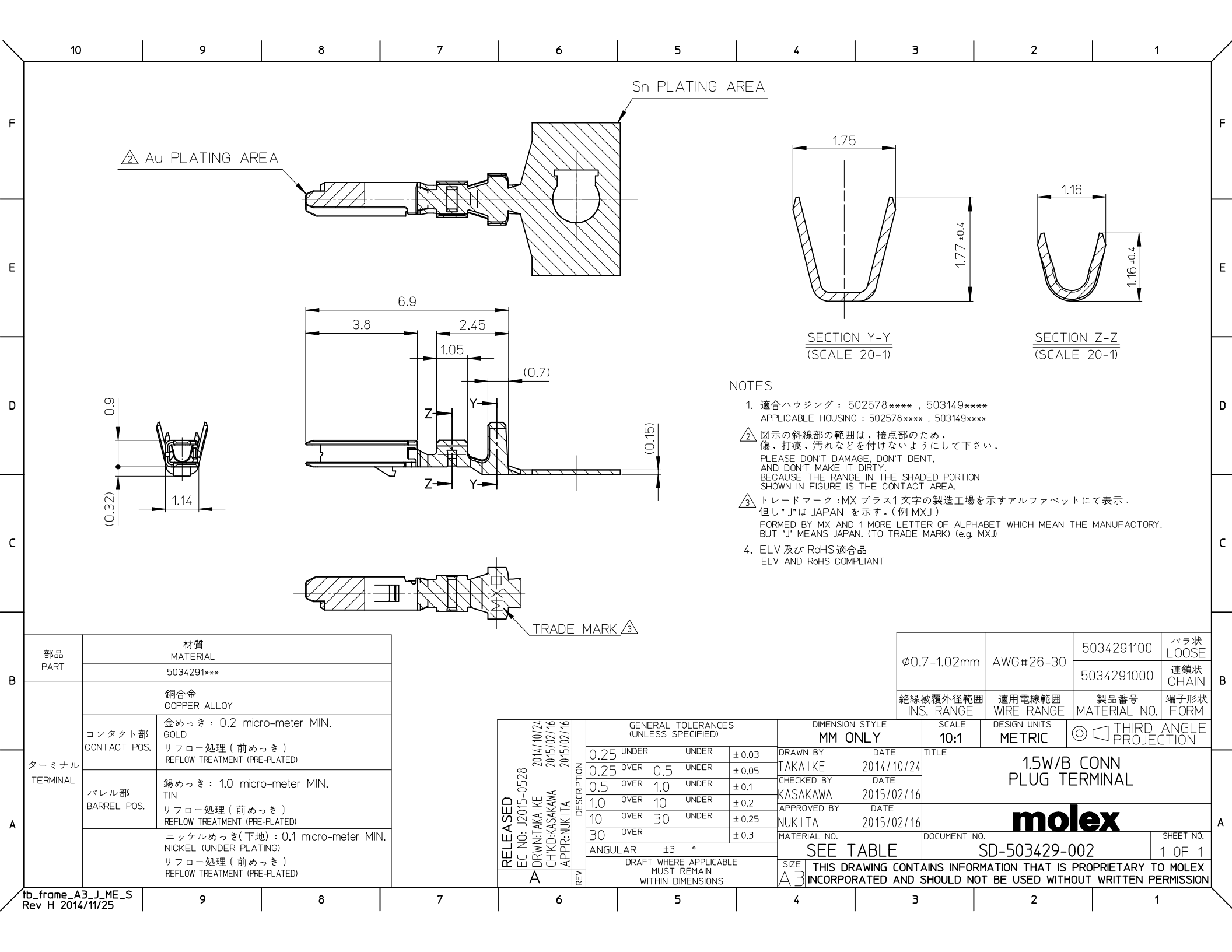


部品 PART	材質 MATERIAL
ターミナル TERMINAL	銅合金 COPPER ALLOY
	錫めっき：0.4 micro-meters MIN リフロー処理(前めっき) MATTE TIN REFLOW TREATMENT (PRE-PLATING)
	ニッケルめっき(下地)：0.1 micro-meters MIN NICKEL PLATING (UNDER PLATING)

DOCUMENT STATUS	P1	RELEASE DATE	2020/03/03	06:59:12
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Ø0.7-1.02mm	AWG #26-30	503429 0000	連鎖状 CHAIN
絶縁被覆外形範囲 INS RANGE	適用電線範囲 WIRE RANGE	オーダー番号 ORDER NO	端子形状 FORM

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION												
DIMENSION UNITS		SCALE		CURRENT REV DESC:			molex					
mm		NTS										
GENERAL TOLERANCES (UNLESS SPECIFIED)				CLIK-MATE 1.5 CRIMP TERMINAL TIN PLATING AWG26-30								
ANGULAR TOL ± 3.0 °				EC NO: 632623								
4 PLACES ± 0.2				DRWN: MIKEDA01 2019/04/11								
3 PLACES ± 0.2				CHK'D: SAKIYAMA 2020/02/28								
2 PLACES ± 0.2				APPR: KOMURAKAMI 2020/03/03								
1 PLACE ± 0.2				INITIAL REVISION:								
0 PLACES ± 0.2				DRWN: MIKEDA01 2019/04/11								
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				APPR: KOMURAKAMI 2020/03/03								
THIRD ANGLE PROJECTION			DRAWING		SERIES		MATERIAL NUMBER		CUSTOMER		SHEET NUMBER	
			A3-SIZE		503429		5034290000		GENERAL		1 OF 2	



部品 PART	材質 MATERIAL
	5034291***
ターミナル TERMINAL	銅合金 COPPER ALLOY
	金めっき: 0.2 micro-meter MIN. GOLD リフロー処理 (前めっき) REFLOW TREATMENT (PRE-PLATED)
	バレル部 BARREL POS.
	錫めっき: 1.0 micro-meter MIN. TIN リフロー処理 (前めっき) REFLOW TREATMENT (PRE-PLATED)
	ニッケルめっき (下地): 0.1 micro-meter MIN. NICKEL (UNDER PLATING) リフロー処理 (前めっき) REFLOW TREATMENT (PRE-PLATED)

RELEASED EC NO: J2015-0528 2014/10/24 DRWN: TAKAIKE CHKD: KASAKAWA APPR: NUKITA 2015/02/16 2015/02/16	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE MM ONLY		SCALE 10:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION	
		0.25 UNDER UNDER ± 0.03			DRAWN BY DATE		TITLE 1.5W/B CONN PLUG TERMINAL molex			
		0.25 OVER 0.5 UNDER ± 0.05			TAKAIKE 2014/10/24					
		0.5 OVER 1.0 UNDER ± 0.1			CHECKED BY DATE					
		1.0 OVER 10 UNDER ± 0.2			KASAKAWA 2015/02/16		SD-503429-002			
		10 OVER 30 UNDER ± 0.25			APPROVED BY DATE					
		30 OVER ± 0.3			NUKITA 2015/02/16					
		ANGULAR ±3 °			MATERIAL NO.					
					SEE TABLE		DOCUMENT NO.			SHEET NO.
					SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			